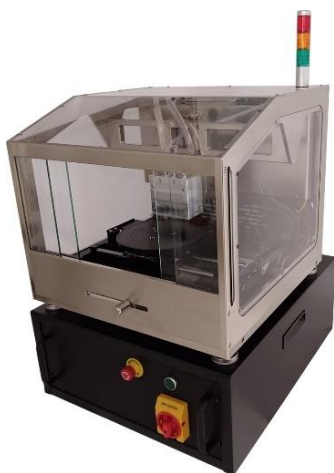


PRESS RELEASE

Saint-Jeoire (France) - January 22nd, 2021

SET European reseller of the Ontos^{TT} atmospheric plasma system

The world's leading supplier of high precision flip-chip bonders **SET** will now supply in Europe the Ontos^{TT} stand-alone atmospheric plasma system, designed and made by the American OES (ONTOS Equipment Systems).



Dedicated to surface preparation

Semi-automatic, table-top, the Ontos^{TT} System is proposed in 2 versions - **200 mm** and **300 mm**.

2 sizes of plasma head are available - 25 mm and 40 mm.

Ontos^{TT} provides an **effective and clean surface modification method** which does not require the throughput-robbing vacuum chamber associated with traditional plasma systems.

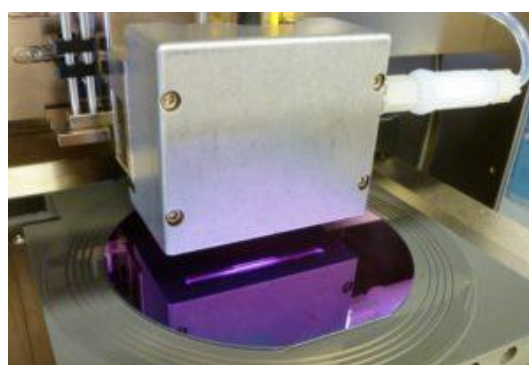
It performs this surface modification **without ion bombardment** and **without the cross-contamination issues** often associated with conventional plasma systems.

Ontos/S (OEM): atmospheric plasma head for integration into third party equipment

The OEM version of the Ontos plasma head is available for integration into third party equipment.

3 sizes of plasma head are available – 10 mm, 25 mm and 40 mm.

The Ontos/S system is available on SET **FC300 Flip-Chip Bonder**.



For more information

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